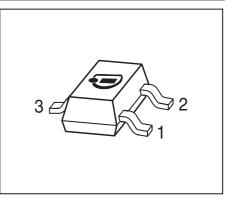


BFR93A

NPN Bipolar RF Transistor

- For low-noise, high gain broadband amplifiers at collector currents from 2 mA to 30 mA
- Pb-free (RoHS compliant) package
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking		Pin Configuration			Package	
BFR93A	R2s	1=B		2=E 3=C		SOT23	
Maximum Ratings at $T_A = 2$	5 °C, unless	otherwi	ise sp	ecified			
Parameter		Syr	nbol	Value	Unit		
Collector-emitter voltage			V _{CEO}		12	V	
Collector-emitter voltage Collector-base voltage		VCE	V _{CES}				
Emitter-base voltage	mitter-base voltage		VEE		2		
Collector current	ollector current		I _C		90	mA	
Base current			I _B		9		
Total power dissipation ¹⁾			Ptot		300	mW	
<i>T</i> _S ≤ 106 °C				-			
Junction temperature	iction temperature		TJ		150	°C	
Storage temperature		T _{Stg}		-55 15	0		

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	145	K/W

 ${}^{1}T_{S}$ is measured on the collector lead at the soldering point to the pcb

²For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0					
Collector-emitter cutoff current	ICES	-	-	100	μA
$V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	10	μA
$V_{\rm EB}$ = 2.5 V, $I_{\rm C}$ = 0					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified



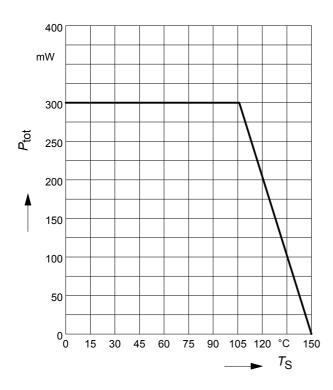
Parameter	Symbol	Values			Unit	
		min.	typ.	max.		
AC Characteristics (verified by random sampling)						
Transition frequency	f _T	4.5	6	-	GHz	
<i>I</i> _C = 30 mA, <i>V</i> _{CE} = 8 V, <i>f</i> = 500 MHz						
Collector-base capacitance	C _{cb}	-	0.54	0.8	pF	
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,						
emitter grounded						
Collector emitter capacitance	C _{ce}	-	0.25	-		
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,						
base grounded						
Emitter-base capacitance	C _{eb}	-	1.9	-		
$V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,						
collector grounded						
Minimum noise figure	NF _{min}				dB	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 900 MHz		-	1.5	-		
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 1.8 GHz		-	2.6	-		
Power gain, maximum available ¹⁾	G _{ma}					
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,						
<i>f</i> = 900 MHz		-	14.5	-		
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,						
<i>f</i> = 1.8 GHz		-	9.5	-		
Transducer gain	S _{21e} ²				dB	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
<i>f</i> = 900 MHz		-	12.5	-		
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
<i>f</i> = 1.8 MHz		-	7	-		

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

 ${}^{1}G_{\text{ma}} = |S_{21e} / S_{12e}| (k - (k^{2} - 1)^{1/2})$

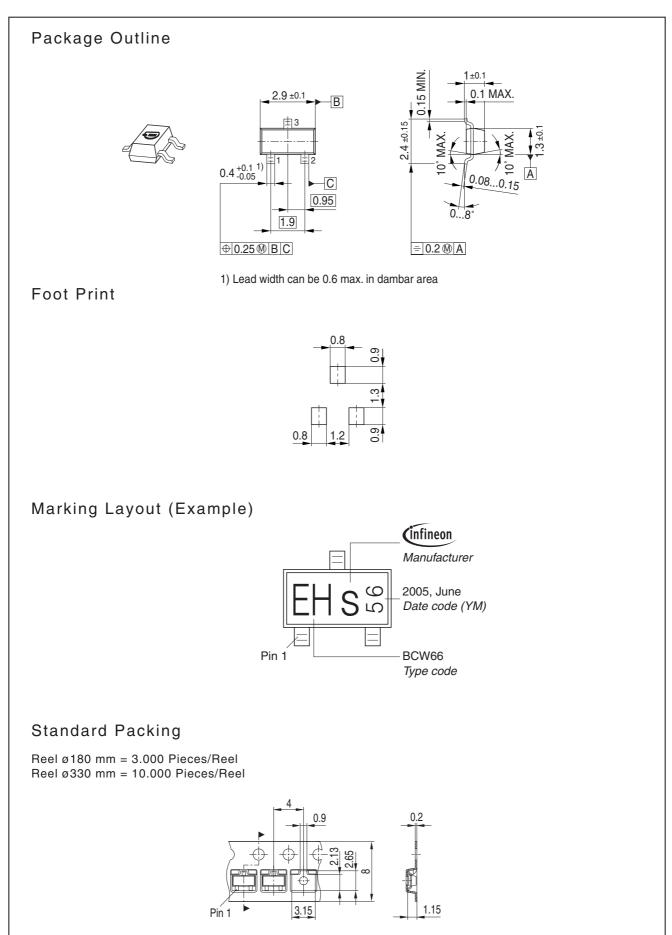


Total power dissipation $P_{tot} = f(T_S)$





BFR93A







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